

Technical Data Sheet (Preliminary) **Power Top View LED With LENS**

67-31B/GLC-AV2X1M/2T

Features

- PLCC-3 package.
- High flux output.
- High current capability.
- White package.
- Optical indicator.
- Colorless clear window.
- Ideal for backlight and light pipe application.
- Inter reflector.
- Wide viewing angle.
- Suitable for automatic placement equipment.
- Suitable for reflow and wave solder processes.
- Available on tape and reel (12mm Tape).
- Pb-free.
- The product itself will remain within RoHS compliant version.



The 67-31B series is available in soft orange, red and yellow. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector.

This feature makes the ideal for light pipe application. The low current requirement makes this device ideal for portable equipment or any other application where power is at a premium.

Applications

- Indicator and backlight for audio and video equipment.
- Indicator and backlight in office and family equipment.
- Flat backlight for LCD's, switches and symbols.
- Light pipe application.
- · General use.

Device No.:

Device Selection Guide

	Lens Color		
Material	Emitted Color	Lens Color	
InGaN	Bluish Green	Water Clear	

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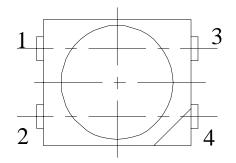
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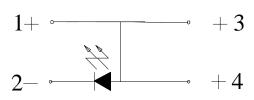
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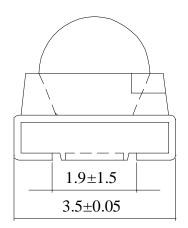
Page: 1 of 10

67-31B/GLC-AV2X1M/2T

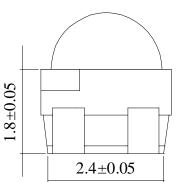
Package Dimensions

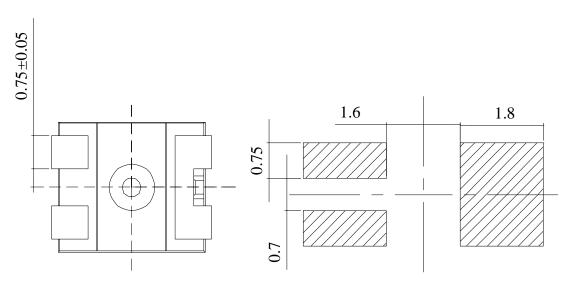












Recommendead Soldering Pad Desigh

Note: The tolerances unless mentioned is ± 0.1 mm; Unit = mm

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Page: 2 of 10



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Absolute Maximum Ratings ($T_A=25^{\circ}C$)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_R	5	V
Forward Current	I_F	25	mA
Operating Temperature	T_{opr}	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	T_{stg}	-40 ~ +100	$^{\circ}\!\mathbb{C}$
Electrostatic Discharge(HBM)	ESD	150	V
Power Dissipation	Pd	110	mW
Peak Forward Current (Duty 1/10 @1KHz)	IFP	100	mA
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec Hand Soldering: 350 °C for 3 sec.	

Electronic Optical Characteristics:

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Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Luminous Intensity	$I_{\rm v}$	2250		4500	mcd	IF =20mA	
Viewing Angle	$2 heta_{1/2}$		60		deg	IF =20mA	
Peak Wavelength	λР		518		nm	IF =20mA	
Dominant Wavelength	λd	520		535	nm	I _F =20mA	
Spectrum Radiation Bandwidth	Δλ		18		nm	I _F =20mA	
Forward Voltage	VF	2.75		3.95	V	IF =20mA	
Reverse Current	I_R			10	μ A	V _R =5V	

Notes:

- 1.Tolerance of Luminous Intensity ±10%
- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.1V

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Device No.:

http://www.everlight.com

prepared date:11-Jul-2006

Rev. 1

Page: 3 of 10



67-31B/GLC-AV2X1M/2T

Bin Range Of Dominant Wavelengths

Group	Bin	Min	Max	Unit	Condition	
Y	B1	499.5	501.5		I _F =20mA	
	B2	501.5	503.5			
	В3	503.5	505.5	nm		
	B4	505.5	507.5			
	B5	507.5	509.5			
	В6	509.5	511.5			
	В7	511.5	513.5			
	В8	513.5	515.5			

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition	
V2	900	1120			
W1	1120	1420	1	IF =20mA	
W2	1420	1800	mcd		
X1	1800	2250			

Bin Range Of Forward Voltage

Group	Bin	Min	Max	Unit	Condition	
М	5	2.75	3.05			
	6	3.05	3.35	V	IF =20mA	
	7	3.35	3.65	V		
	8	3.65	3.95			

Notes:

- 1.Tolerance of Luminous Intensity ±10%
- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.1V

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Device No.:

http://www.everlight.com prepared date:11-Jul-2006

Rev. 1

Page: 4 of 10

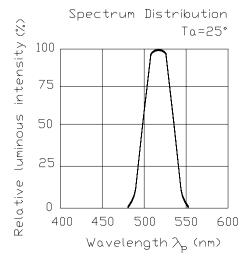
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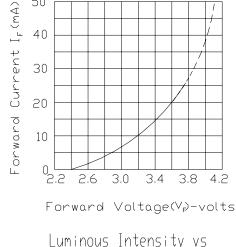
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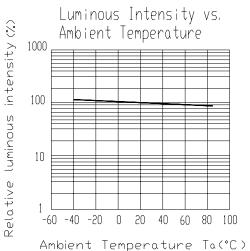
Ta=25°

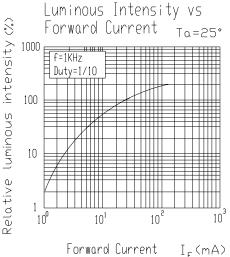
Typical Electro-Optical Characteristic Curves

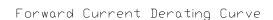


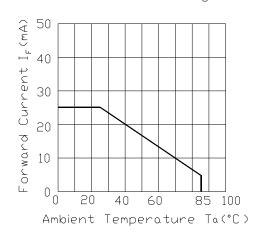


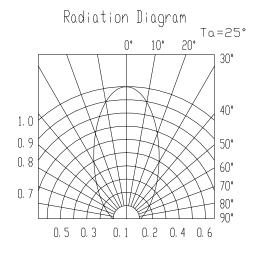
Forward Voltage













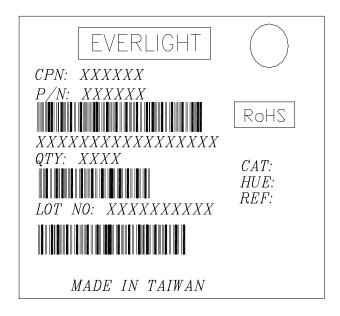
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Label explanation

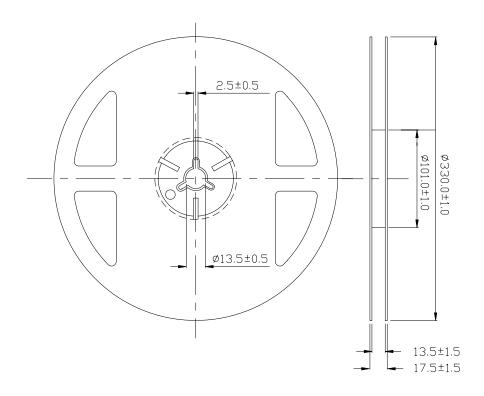
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions

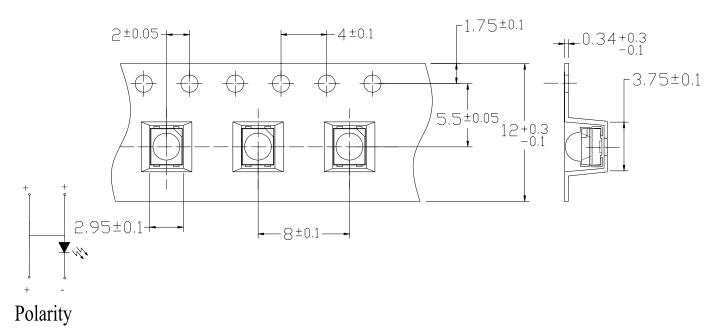


Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm



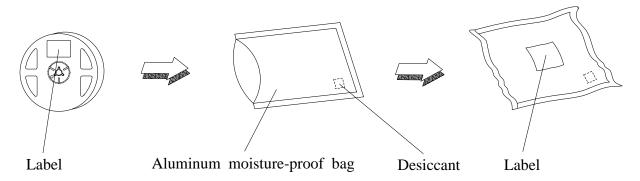
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Carrier Tape Dimensions; Loaded quantity per reel 2000 PCS/reel



Note: Tolerances Unless Dimension ± 0.1 mm Unit = mm

Moisture Resistant Packaging



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Page: 7 of 10



67-31B/GLC-AV2X1M/2T

Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5 sec.	6 Min.	22 PCS	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°€	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA} / 25^{\circ}\text{C}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/85%RH	1000 Hrs.	22 PCS.	0/1

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Page: 8 of 10



67-31B/GLC-AV2X1M/2T

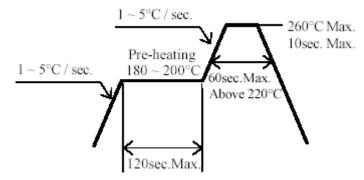
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.
- 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

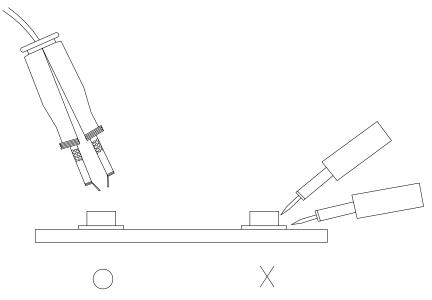
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67-31B/GLC-AV2X1M/2T

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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